

LFWLP225-CK COVER KIT



Features

- Noncorrosive
- Easy assembly
- Low weight
- Fully safe

FOR WLP225, MWLP225 SERIES

Derating Guidelines

WLP225/MWLP225: De-rate to 70% of values mentioned in temperature de-rating curves of open frame models at all load and ambient conditions.

Contents

Mounting Base, Cover, Insulator, Fixing Screws

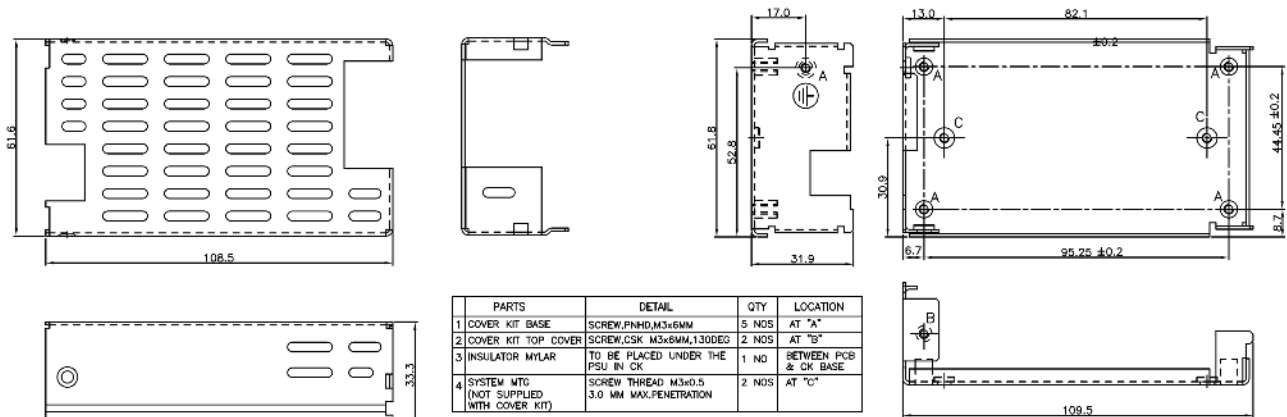
Mechanical Dimensions

Cover and Base Material EG(Zintec)/CRCA/GI 1.0mm thick (Powder coating/ Passivation/ ED coating black)

Marked A: PCB MTG; B: COVER MTG; C: SYSTEM MTG, M3 Thread

All dimensions are in mm. General tolerance :+/-1.0

Mechanical Drawing



PARTS	DETAIL	QTY	LOCATION
1 COVER KIT BASE	SCREW,PNHD,M3x6MM	5 NOS	AT "A"
2 COVER KIT TOP COVER	SCREW,CSK M3x6MM,130DEG	2 NOS	AT "B"
3 INSULATOR MYLAR	TO BE PLACED UNDER THE PSU IN CK	1 NOS	BETWEEN PCB & CK BASE
4 SYSTEM MTG (NOT SUPPLIED WITH COVER KIT)	SCREW THREAD M3x0.5 3.0 MM MAX.PENETRATION	2 NOS	AT "C"

*ITEM NO 3 PART DETAILS.

MANUFACTURER	MPN	DESCRIPTION
DUPONT TELIN FILMS USLP	MYLAR M031	POLYETHYLENE TEREPHTHALATE(PET)MYLAR MIN THK 0.25MM,VTM-2

WLP225-CK.
MECHANICAL OUTLINE DIMENSIONS.